

SGM8904 Capless 2Vrms to 3Vrms Line Driver with Adjustable Gain

GENERAL DESCRIPTION

The SGM8904 is a 2Vrms to 3Vrms pop/click-free stereo line driver designed to allow the removal of the output DC-blocking capacitors for reduced component count and cost. The device is ideal for single supply electronics where size and cost are critical design parameters.

The SGM8904 is capable of driving 3Vrms into a $2.5k\Omega$ load with 5V supply voltage. The device has single input and uses external gain setting resistors that supports a gain range of $\pm 1 \text{V/V}$ to $\pm 10 \text{V/V}$. The use of external gain resistors also allows the implementation of a 2nd-order low pass filter to compliment DAC's and SOC converters. The SGM8904 has build-in shutdown control for pop/click-free on/off control.

Using the SGM8904 in audio products can reduce component count compared to traditional methods of generating a 3Vrms output. The SGM8904 doesn't require a power supply greater than 5V to generate an 8.5V_{PP} output, nor does the device require a split rail power supply. The SGM8904 integrates a charge pump to generate a negative supply rail that provides a clean, pop/click-free ground-biased 3Vrms output.

The SGM8904 is available in Green MSOP-10 package. It operates over an ambient temperature range of -40°C to +85°C.

FEATURES

- Capless Structure
 Eliminates Pop/Clicks
 Eliminates Output DC-Blocking Capacitors
 Provides Flat Frequency Response from DC to 20kHz
- Low Noise and THD
 Typical SNR = 114dB
 Typical V_N = 5.4μVrms
 Typical THD+N = 0.001% (f = 1kHz)
- 2Vrms Output Voltage into 2.5kΩ Load with 3.3V Supply Voltage
- 3Vrms Output Voltage into 2.5kΩ Load with 5V Supply Voltage
- -40°C to +85°C Operating Temperature Range
- Available in the Green MSOP-10 Package

APPLICATIONS

Set-Top Box LCD TV Blue-Ray DVD-Players

Home Theater in a Box



PACKAGE/ORDERING INFORMATION

MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	RATURE ORDERING PACK		PACKING OPTION
SGM8904	MSOP-10	-40°C to +85°C	SGM8904YMS10G/TR	SGM8904 YMS10 XXXXX	Tape and Reel, 4000

NOTE: XXXXX = Date Code and Vendor Code.

Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

ABSOLUTE MAXIMUM RATINGS

Supply Voltage	0.3V to 6V
Input Voltage	V_{SS} - 0.3V to V_{DD} + 0.3V
Minimum Load Impedance (R _L)	600Ω
EN to GND	0.3V to V _{DD} + 0.3V
Junction Temperature	+150°C
Storage Temperature Range	65°C to +150°C
Lead Temperature (Soldering, 10s)	+260°C
ESD Susceptibility	
HBM	6000V
MM	300V
CDM	1000V

RECOMMENDED OPERATING CONDITIONS

Supply Voltage Range	3V to 5.5V
Operating Temperature Range	40°C to +85°C

OVERSTRESS CAUTION

Stresses beyond those listed may cause permanent damage to the device. Functional operation of the device at these or any other conditions beyond those indicated in the operational section of the specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

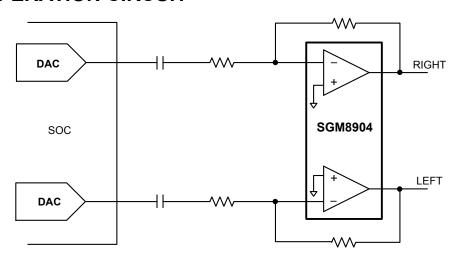
ESD SENSITIVITY CAUTION

This integrated circuit can be damaged by ESD if you don't pay attention to ESD protection. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

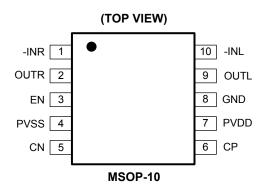
DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, specification or other related things if necessary without notice at any time.

TYPICAL OPERATION CIRCUIT



PIN CONFIGURATION



PIN DESCRIPTION

PIN	NAME	FUNCTION
1	-INR	Right Channel OPAMP Negative Input.
2	OUTR	Right Channel OPAMP Output.
3	EN	Enable Input. Active high.
4	PVSS	Negative Supply Voltage Output.
5	CN	Charge Pump Flying Capacitor Negative Terminal.
6	CP	Charge Pump Flying Capacitor Positive Terminal.
7	PVDD	Positive Supply.
8	GND	Ground.
9	OUTL	Left Channel OPAMP Output.
10	-INL	Left Channel OPAMP Negative Input.

ELECTRICAL CHARACTERISTICS

 $(T_A = +25^{\circ}C, \text{ unless otherwise noted.})$

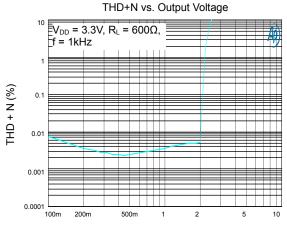
PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS	
ELECTRICAL CHARACTERISTICS						
DC Supply Voltage (V _{DD})		3		5.5	V	
Output Offset Voltage (Vos)	V _{DD} = 3V to 5V		1	5.5	mV	
Power Supply Rejection Ratio (PSRR)	V _{DD} = 3V to 5V		100		dB	
High-Level Output Voltage (V _{OH})	$V_{DD} = 3.3V, R_{L} = 2.5k\Omega$	3.18			V	
Low-Level Output Voltage (V _{OL})	$V_{DD} = 3.3V, R_{L} = 2.5k\Omega$			-3.05	V	
High-Level Input Current (EN) (I _{IH})	$V_{DD} = 5V, V_I = V_{DD}$			1	μA	
Low-Level Input Current (EN) (I _{IL})	V _{DD} = 5V, V _I = 0V			1	μA	
	V_{DD} = 3.3V, No load, EN = V_{DD}		11	14.8		
Supply Current (I _{DD})	V_{DD} = 5V, No load, EN = V_{DD}		12	15.8	mA	
	Shutdown mode, V _{DD} = 3V to 5V		0.13	0.18	1	
OPERATING CHARACTERISTICS (V _{DD} = 3.3V,	R_L = 2.5k Ω , C_{PUMP} = C_{PVSS} = 1 μ F, C_{IN} = 10 μ F, R_{IN}	= 10kΩ, R _{FE}	$_3$ = 20k Ω .)	1)	•	
	THD = 1%, V _{DD} = 3.3V, f = 1kHz	2.05				
Output Voltage (Outputs In Phase) (Vo)	THD = 1%, V _{DD} = 5V, f = 1kHz	3.05			Vrms	
	THD = 1%, V_{DD} = 5V, f = 1kHz, R_{L} = 100kΩ	3.1				
Total Harmonic Distortion Plus Noise (THD+N)	V _O = 2Vrms, f = 1kHz		0.001		%	
Crosstalk	V _O = 2Vrms, f = 1kHz		95		dB	
Output Current Limit (I _O)	V _{DD} = 3.3V		20		mA	
Input Resistor Range (R _{IN})			10		kΩ	
Feedback Resistor Range (R _{FB})			20		kΩ	
Slew Rate			10		V/µs	
Maximum Capacitive Load			220		pF	
Noise Output Voltage (V _N)	A-weighted, BW = 20kHz		5.4		μVrms	
Signal to Noise Ratio (SNR)	A-weighted, V _O = 2Vrms, BW = 20kHz		114		dB	
Unity Gain Bandwidth (G _{BW})			8		MHz	
Open-Loop Voltage Gain (A _{VO})			100		dB	
Charge Pump Frequency (F _{CP})		310	450	590	kHz	
EN PIN		•	•	•	•	
Input High Voltage (V _{INH})	EN	1.2			V	
Input Low Voltage (V _{INL})	EN			0.6	V	

NOTE:

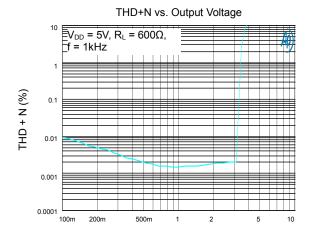
1. For C_{PUMP}, C_{PVSS}, C_{IN}, R_{IN} and etc, please refer to the APPLICATION CIRCUIT on page 7.

TYPICAL PERFORMANCE CHARACTERISTICS

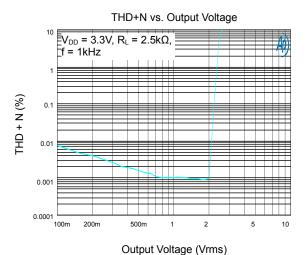
 $T_{A} = +25^{\circ}\text{C}, \ R_{L} = 2.5\text{k}\Omega, \ C_{PUMP} = C_{PVSS} = 1\mu\text{F}, \ C_{IN} = 10\mu\text{F}, \ R_{IN} = 10\text{k}\Omega, \ R_{FB} = 20\text{k}\Omega, \ unless \ otherwise \ noted.$



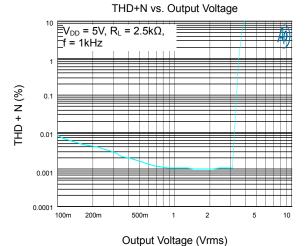




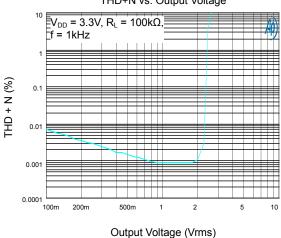
Output Voltage (Vrms)



THD+N vs. Output Voltage



THD+N vs. Output Voltage



0.001 0.0001 0.0001 100m 200m 500m 1 2 5 10

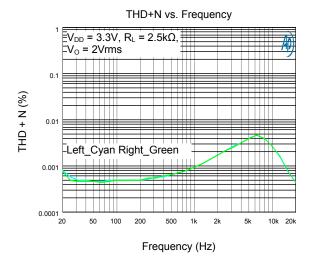
 $V_{DD} = 5V$, $R_L = 100$ k Ω

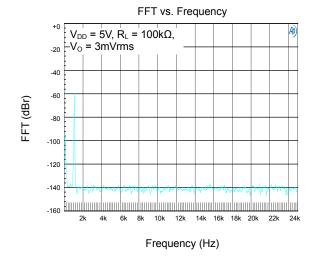
f = 1kHz

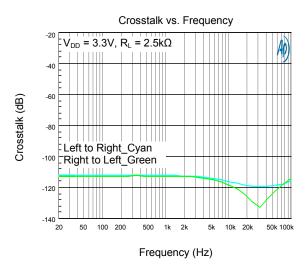
Output Voltage (Vrms)

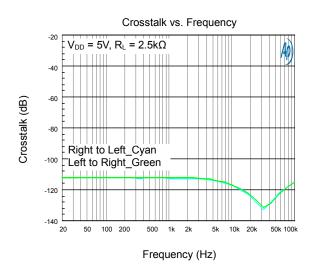
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

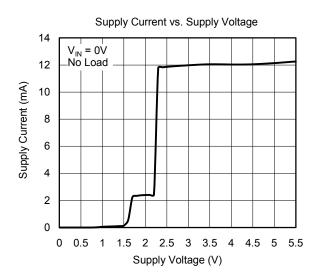
 $T_{A} = +25^{\circ}\text{C}, \ R_{L} = 2.5\text{k}\Omega, \ C_{PUMP} = C_{PVSS} = 1\mu\text{F}, \ C_{IN} = 10\mu\text{F}, \ R_{IN} = 10\text{k}\Omega, \ R_{FB} = 20\text{k}\Omega, \ unless \ otherwise \ noted.$



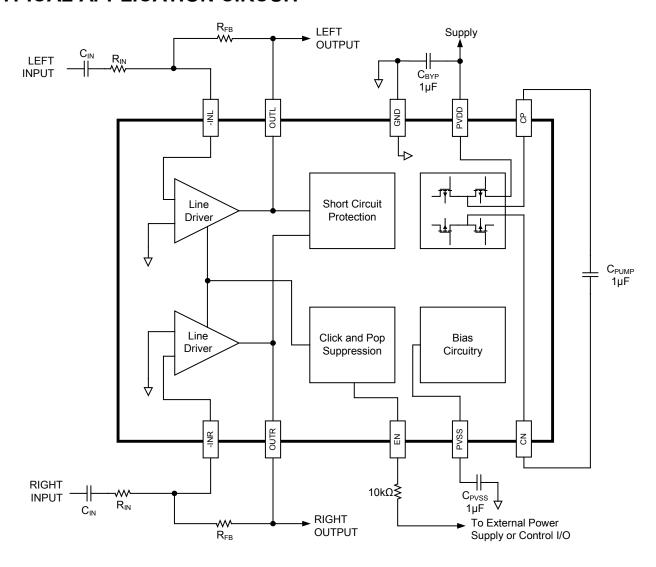








TYPICAL APPLICATION CIRCUIT



NOTES:

- 1. In order to get good performance, it's important to select the right C_{PUMP} , C_{PVSS} and C_{BYP} in application. All tests are performed with circuit set up with X5R and X7R capacitors. Capacitors having high dissipative loss, such as Y5V capacitor, may cause performance degradation and unexpected system behavior.
- 2. A $10k\Omega$ resistor is recommended to be put between EN pin and external power supply or control I/O.

APPLICATION INFORMATION

Decoupling Capacitors

The SGM8904 is a capless line driver amplifier that requires adequate power supply decoupling to ensure that the noise and total harmonic distortion (THD) are low. A good low equivalent-series-resistance (ESR) ceramic capacitor, typically $1\mu F$, placed as close as possible to the device V_{DD} lead, works best. Placing this decoupling capacitor close to the SGM8904 is important for the performance of the amplifier. For filtering lower frequency noise signals, a $10\mu F$ or larger capacitor placed near the audio power amplifier would also help, but it is not required in most applications because of the high PSRR of this device.

Input-Blocking Capacitors

DC input-blocking capacitors are required to be added in series with the audio signal into the input pins of the SGM8904. These capacitors block the DC portion of the audio source and allow the SGM8904 inputs to be properly biased to provide maximum performance. The input-blocking capacitors also limit the DC-gain to one, limiting the DC-offset voltage at the output.

These capacitors form a high-pass filter with the input resistor, R_{IN} . The cutoff frequency is calculated using Equation 1. For this calculation, the capacitance used is the input-blocking capacitor and the resistance is the input resistor, then the frequency and/or capacitance can be determined when one of the two values are given.

$$fc_{IN} = \frac{1}{2\pi R_{IN} C_{IN}} \text{ or } C_{IN} = \frac{1}{2\pi f c_{IN} R_{IN}}$$
 (1)

Pop-Free Power-Up

Pop-free power-up is ensured by keeping the \overline{SD} (EN) (shutdown pin) low during power supply ramp up and down. The EN pin should be kept low until the input AC coupling capacitors are fully charged before asserting the EN pin high. This way proper precharge of the AC coupling is performed, and pop-free power-up is achieved. Figure 1 illustrates the preferred sequence.

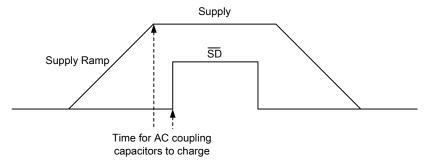


Figure 1. Power-Up Sequence

Capacitive Load

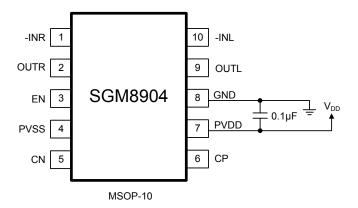
The SGM8904 has the ability to drive large capacitive load up to 220pF directly, and larger capacitive loads can be accepted by adding a series resistor of 47Ω or larger.

Gain-Setting Resistors

The gain setting resistors, R_{IN} and R_{FB} , must be placed close to the input pins to minimize the capacitive loading on these pins and to ensure maximum stability of the SGM8904.

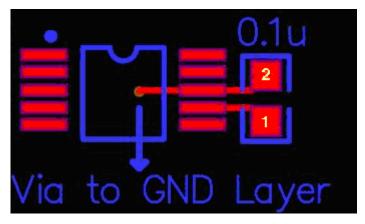
APPLICATION INFORMATION (continued)

PCB Layout Guide

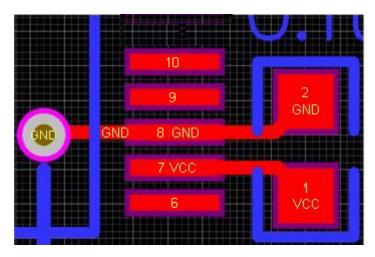


NOTE: 0.1µF decoupling capacitor must be close to GND and PVDD pins; capacitor can be connected between PVDD and GND pins directly and then connect GND pin to GND layer.

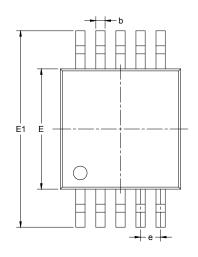
The reference PCB layout is shown in below:

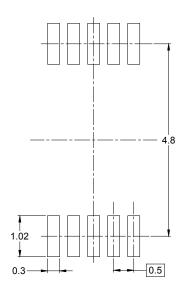


Zoomed in:

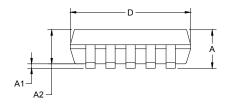


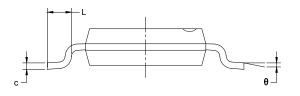
PACKAGE OUTLINE DIMENSIONS MSOP-10





RECOMMENDED LAND PATTERN (Unit: mm)

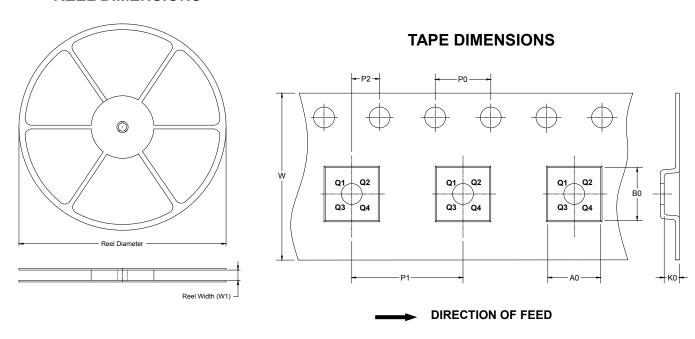




Symbol		nsions meters	Dimensions In Inches		
	MIN MAX		MIN	MAX	
Α	0.820	1.100	0.032	0.043	
A1	0.020	0.150	0.001	0.006	
A2	0.750	0.950	0.030	0.037	
b	0.180	0.280	0.007	0.011	
С	0.090	0.230	0.004	0.009	
D	2.900	3.100	0.114	0.122	
E	2.900	3.100	0.114	0.122	
E1	4.750	5.050	0.187	0.199	
е	0.500 BSC		0.020	BSC	
L	0.400	0.800	0.016	0.031	
θ	0°	6°	0°	6°	

TAPE AND REEL INFORMATION

REEL DIMENSIONS

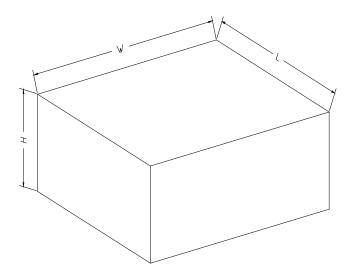


NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
MSOP-10	13"	12.4	5.20	3.30	1.20	4.0	8.0	2.0	12.0	Q1

CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton	
13″	386	280	370	5	